

1. A plastic fluid distribution tank adapted for subterranean burial, having a top and a bottom, comprising:

a first vertical outer wall having a top and a bottom,

a plurality of grooved annular circuits molded on said wall, of equal diameter, the centers of the annular circuits being vertically spaced from one another, formed on the wall so that a hole can be made through the wall at any height of a plurality of heights between the top and the bottom of the wall by removing the portion of the wall that is circumscribed by the circuit at the desired height.

2. A plastic fluid distribution tank adapted for subterranean burial, having a top and a bottom, comprising:

a first vertical outer wall having a top and a bottom,

a plurality of grooved annular circuits molded on said wall, of equal diameter, extending in vertical overlapping sequence, the centers of the annular circuits being vertically spaced from one another, formed on the wall so that a hole can be made through the wall at any height of a plurality of heights between the top and the bottom of the wall by removing the portion of the wall that is circumscribed by the circuit at the desired height.

3. A plastic fluid distribution tank adapted for subterranean burial, having a top, and a bottom, comprising:

a first vertical outer wall having a top and a bottom,

a plurality of grooved annular circuits molded on said wall, of equal diameter, extending in vertical overlapping sequence, the centers of the annular circuits being vertically spaced from one

another, formed on the wall so that a hole can be made through the wall at any height of a plurality of heights between the top and the bottom of the wall by removing the portion of the wall that is circumscribed by the circuit at the desired height, at least two of the grooved circuits being continuous with one another at their intersection.

4. A plastic fluid distribution tank adapted for subterranean burial, having a top, and a bottom, comprising:

a first vertical outer wall having a top and a bottom,

a plurality of grooved annular circuits molded on said wall, of equal diameter, extending in vertical overlapping sequence, the centers of the annular circuits being vertically spaced from one another, formed on the wall so that a hole can be made through the wall at any height of a plurality of heights between the top and the bottom of the wall by removing the portion of the wall that is circumscribed by the circuit at the desired height, at least two of the grooved circuits each being discontinuous at their intersection.

5. A plastic fluid distribution tank adapted for subterranean burial, having a top, and a bottom, comprising:

a first vertical outer wall having a top and a bottom,

a plurality of grooved annular circuits molded on said wall, of equal diameter, extending in vertical overlapping sequence, the centers of the annular circuits being vertically spaced from one another, formed on the wall so that a hole can be made through the wall at any height of a plurality of heights between the top and the bottom of the wall by removing the portion of the wall that is circumscribed by the circuit at the desired height, at least one circuit of said plurality of grooved circuits being discontinuous at an intersection with another circuit of said plurality of grooved annular circuits.

6. The tank of claim 5, further comprising:

a plate, molded in one piece with said tank, mounted on the bottom of said tank by a living hinge configured for vertical movement of said plate.

7. A plastic fluid distribution tank adapted for subterranean burial, having a top and a bottom, comprising:

a first vertical outer wall having a top and a bottom,

a plurality of grooved annular circuits molded on said wall, of equal diameter, extending in vertical overlapping sequence, the centers of the annular circuits being vertically spaced from one another, formed on the wall so that a hole can be made through the wall at any height of a plurality of heights between the top and the bottom of the wall by removing the portion of the wall that is circumscribed by the circuit at the desired height, a first side of a first groove of the plurality of grooved annular circuits sloping at at least two different angles from a line perpendicular to the depth of the groove for guiding cutting in the groove past intersection of said first groove with a second groove of said plurality of grooved annular circuits.

8. The tank of claim 7 wherein said first side of said first groove comprises the outer diameter of the circuit for guiding cutting in the groove past intersection of said first groove with said second groove.

9. The tank of claim 7 wherein said first side and the second side of said first groove slope asymmetrically in cross section for guiding cutting in said first groove past intersection of said first groove with said second groove.

10. The tank of claim 7, further comprising:

a plate, molded in one piece with said tank, mounted on the bottom of said tank by a living hinge configured for vertical movement of said plate.

11. A plastic fluid distribution tank adapted for subterranean burial, having a top and a bottom, comprising:

a first vertical outer wall having a top and a bottom,

a plurality of grooved annular circuits molded on said wall, of equal diameter, extending in vertical overlapping sequence, the centers of the annular circuits being vertically spaced from one another, formed on the wall so that a hole can be made through the wall at any height of a plurality of heights between the top and the bottom of the wall by removing the portion of the wall that is circumscribed by the circuit at the desired height, the opposite sides of a first groove of the plurality of grooved annular circuits sloping asymmetrically in cross section for guiding cutting in said first groove past intersection of said first groove with another groove of the plurality of grooved annular circuits.

12. A plastic fluid distribution tank adapted for subterranean burial, having a top and a bottom, comprising:

a first vertical outer wall having a top and a bottom,

a plurality of grooved circuits molded on said wall, extending in vertical overlapping sequence, the centers of the circuits being vertically spaced from one another, formed on the wall so that a hole can be made through the wall at any height of a plurality of heights between the top and the bottom of the wall by removing the portion of the wall that is circumscribed by the circuit at the desired height.

13. The tank of claim 12 , further comprising:

at least one circuit of said plurality of grooved circuits being discontinuous at an intersection with another circuit of said plurality of grooved circuits.

14. The tank of claim 12, further comprising:

a first side of a first groove of the plurality of grooved circuits sloping at at least two different angles from a line perpendicular to the depth of the groove for guiding cutting in the groove past intersection of said first groove with a second groove of said plurality of grooved circuits.

15. The tank of claim 12, further comprising:

opposite sides of a first groove of the plurality of grooved circuits sloping asymmetrically in cross section for guiding cutting in said first groove past intersection of said first groove with another groove of the plurality of grooved circuits.

16. In a septic system, a plastic fluid distribution tank adapted for subterranean burial, having a top and a bottom, comprising:

a first vertical outer wall having a top and a bottom,

a first hole through said first wall,

means, mounted on said first wall, for sealingly coupling septic system pipe to said first wall for passing fluid between said tank and the pipe by way of said first hole,

a plurality of grooved circuits molded on said first wall, extending in vertical overlapping

sequence, the centers of the circuits being vertically spaced from one another, formed on the wall so that a hole can be made through the wall at any height of a plurality of heights between the top and the bottom of the wall by removing the portion of the wall that is circumscribed by the circuit at the desired height, said first hole being circumscribed by one of said circuits.